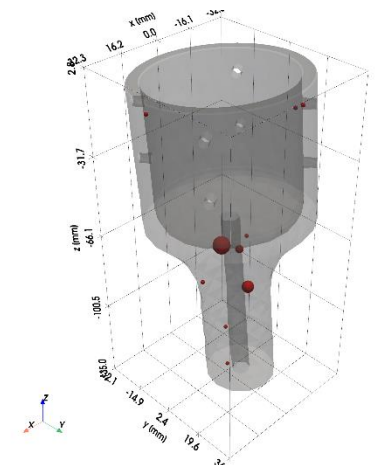
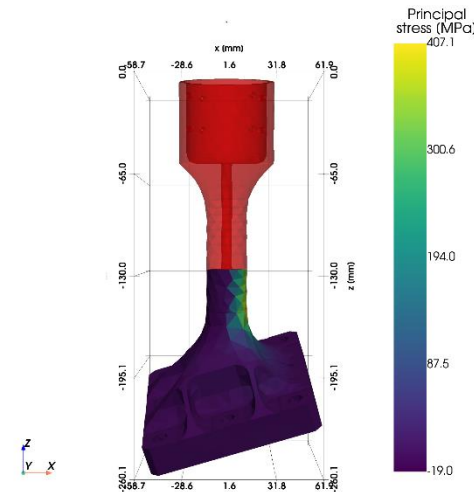
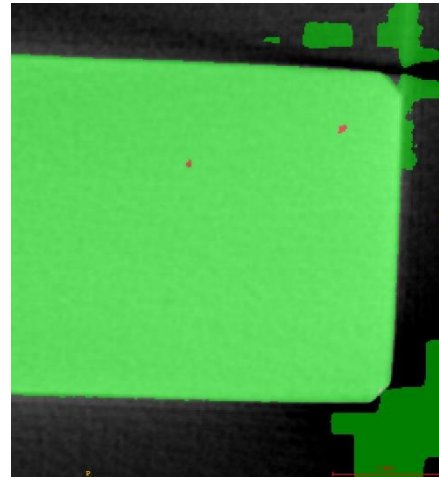
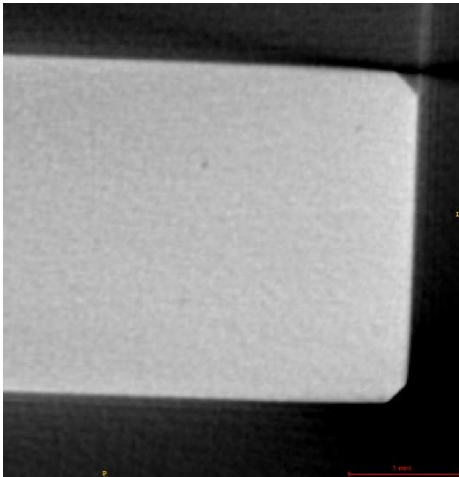


# AI Supported NDI Methods for Ceramic Components

ESA contract no. 4000141359/22/NL/RA/cb

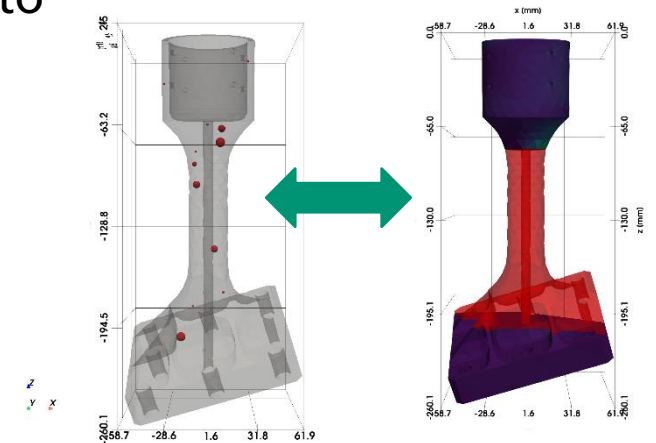
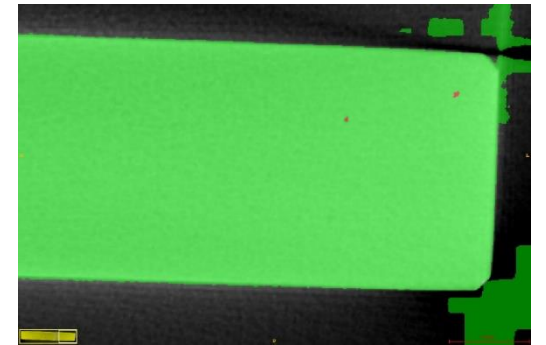
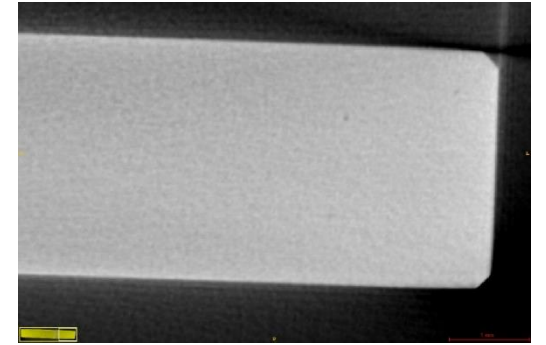
Simon Pirkelmann\*, Gerhard Seifert, Fraunhofer HTL

Final Review at ESTEC (Noordwijk), 11.07.2024



# Project goal

- Develop X-Ray Computed Tomography towards a reasonably fast and reliable non-destructive testing (NDT) technique by combining it with ...
  - appropriate artificial intelligence (AI) algorithms, and
  - Finite Element (FE) analyses of the stress fields under application conditions
- Develop an algorithm for automatized control of the CT inspection process including autonomous identification and scanning of the critical regions to be scanned with high CT resolution
- The technology to be developed shall be suitable for all space-relevant ceramic materials and transferable to material testing in general.

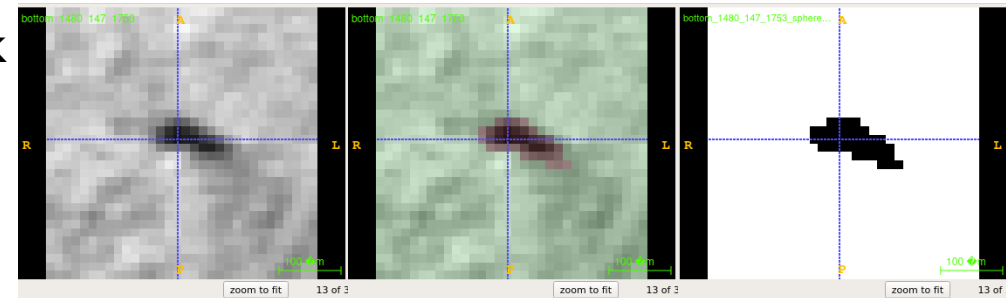
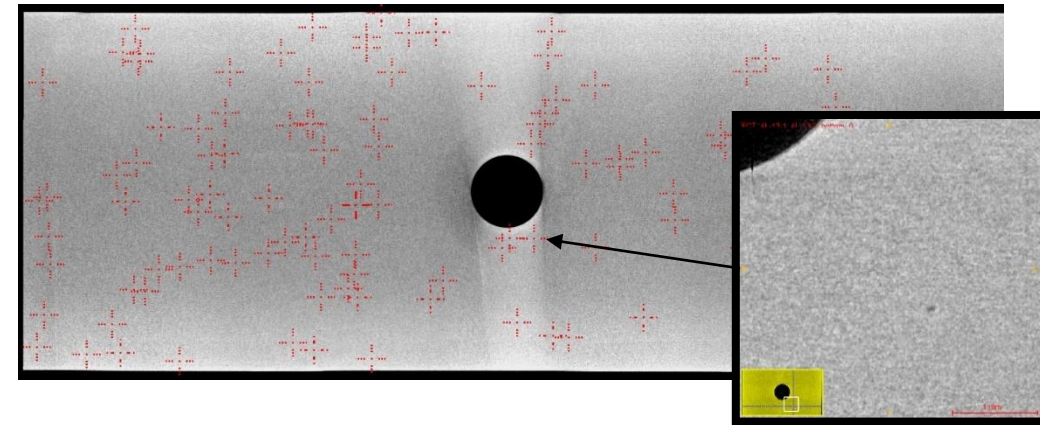


# Summary of performed works

- Development of image segmentation for ceramic CT images (WP1 + WP2)
  - Preparation of training data set based on data from previous project
  - Training and validation of the model
- Selection of demonstrator part (WP3)
  - Lower-end fitting part provided by Thales
  - Execution of CT scans at multiple resolution scales
  - Finite element (FE) mechanical simulations of part under application conditions
- Development of adaptive CT scanning strategy (WP3)
  - Algorithm for assessment of defects in combination with FE data
  - Iterative refinement of scanning resolutions at selected regions of interest

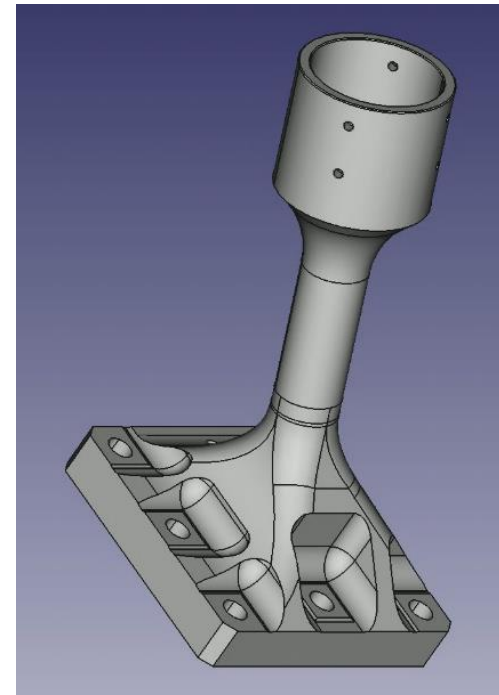
# Revision: Image segmentation algorithm for ceramic CT images (WP1 + WP2)

- Preparation of training data set based on existing data from previous project
  - Utilization of CT scans of  $\text{Si}_3\text{N}_4$  samples
  - Generation of training data from human-labeled defect locations
- Training and validation of the convolutional neural network for 3D segmentation of defects
  - Implementation based on (open source) nnUNet framework
  - Ability of the model to correctly label background, matrix and pores / regions of inhomogeneity
  - Evaluation using additional scans not used during training
  - Delivery of algorithm as Python package (TN3)



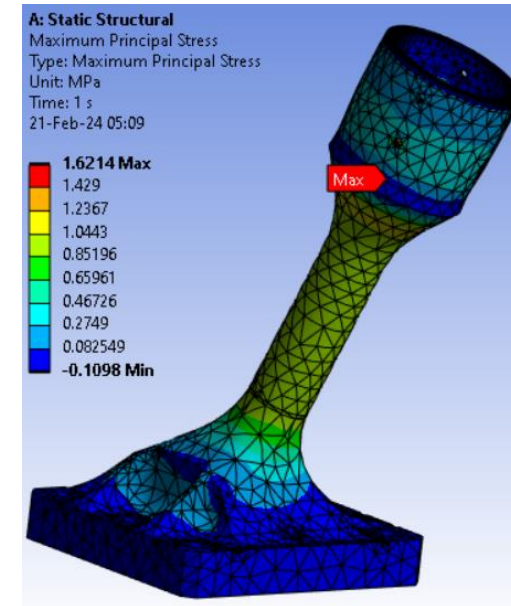
## WP3: Selection of demonstrator part

- $\text{Si}_3\text{N}_4$  lower-end fitting part of a satellite was provided by Thales Alenia Space (TAS)
  - 3D geometry file and report of mechanical simulations
    - Used for 3D mechanical simulations at HTL
  - Physical component
    - Used to demonstrate capabilities of the automated evaluation procedure

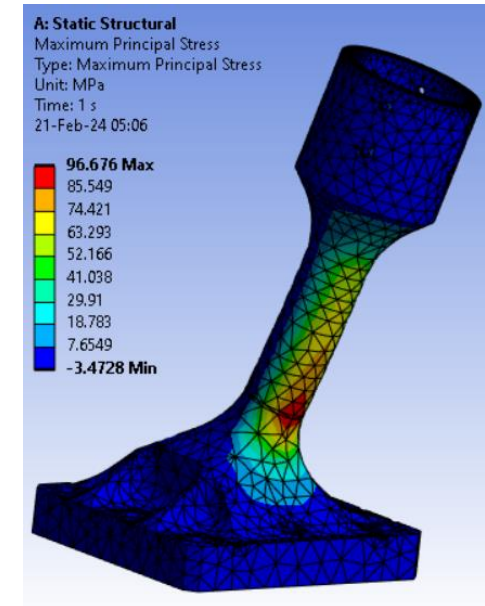


# FE simulations of demonstrator part

- FE simulations of demonstrator part under operating conditions have been carried out (based on supplementary information provided by TAS)
- Boundary conditions:
  - Tensile:
    - Application of unit force of 1000 N along the central axis of the part
  - Bending:
    - Application of unit force of 1000 N orthogonal to central axis
- Resulting spatial distribution of stresses within the material serves as input for adaptive analysis



Tensile load

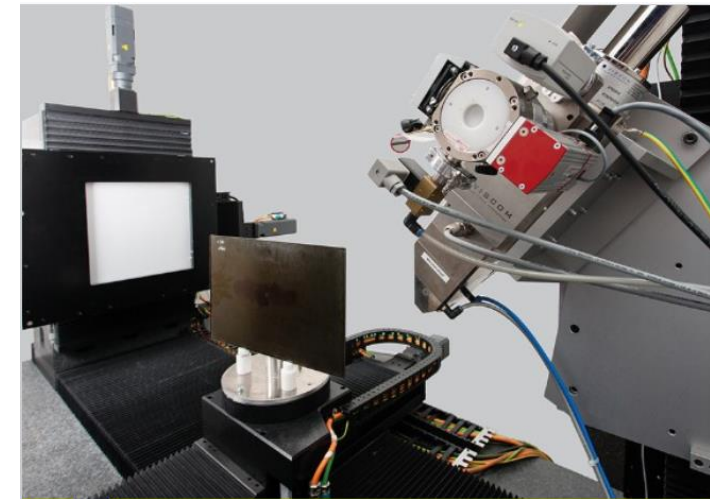


Bending load

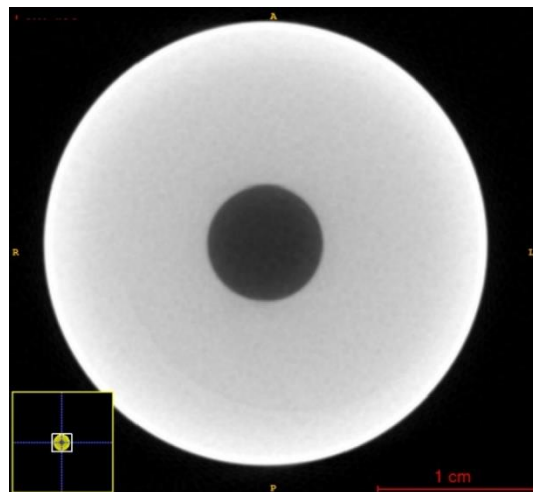
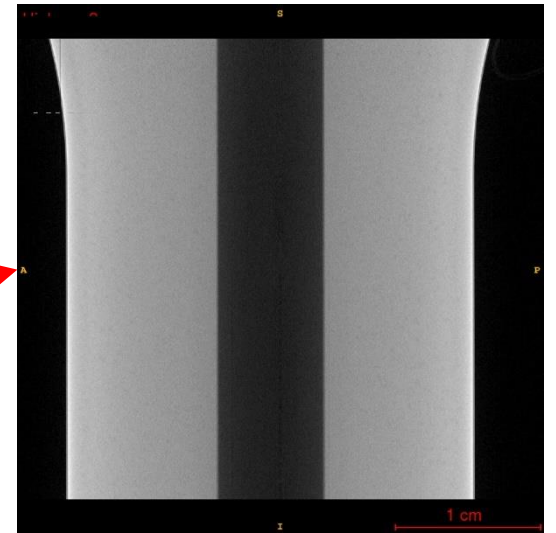
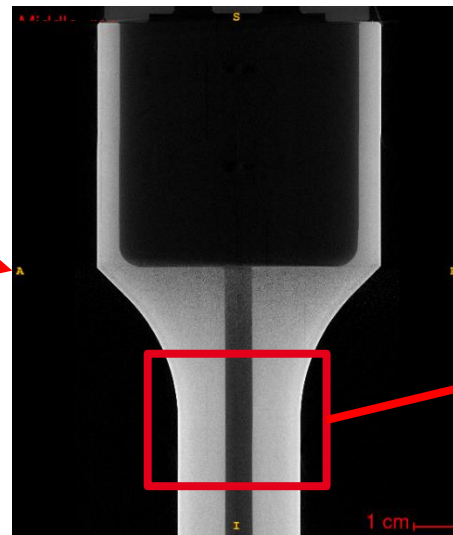
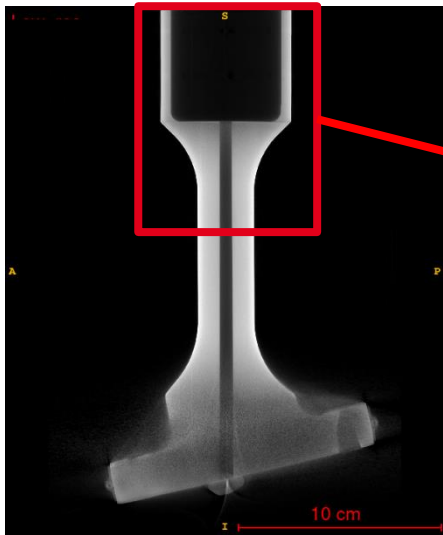
# CT scans of demonstrator part

- CT scans of demonstrator part at different resolution scales have been carried out
- Variation of resolution between 87 and 10 microns
- Scanning time for scans 0 – 2: approx. 90 minutes each
- Scanning time for scan 3: approx. 180 minutes
- Scanning of full part at highest resolution scale would take several days worth of scanning time  
→ not feasible

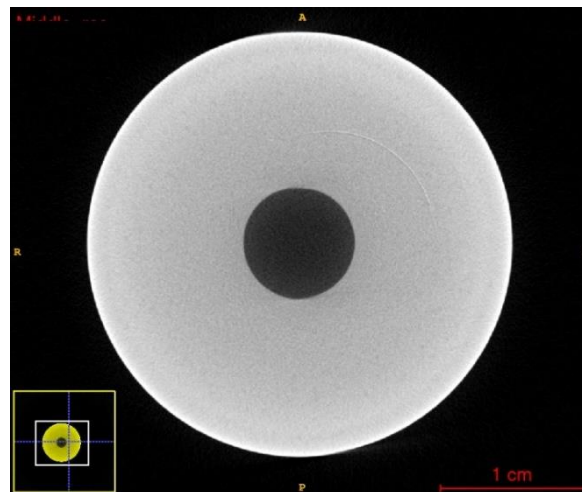
Scan ID	Scan type	Resolution	Voxels	Scan volume [cm <sup>3</sup> ]
0	Full part, low-res	0.08687 mm = 87 μm	1999x1999x3016	7900
1	Upper section, mid-res	0.03682 mm = 37 microns	1999x1999x3261	650
2	Upper section, high-res	0.01815 = 18 microns	1999x1999x1747	41
3	Upper section, very high-res	0.01022 mm = 10 microns	3890x3890x1492	24



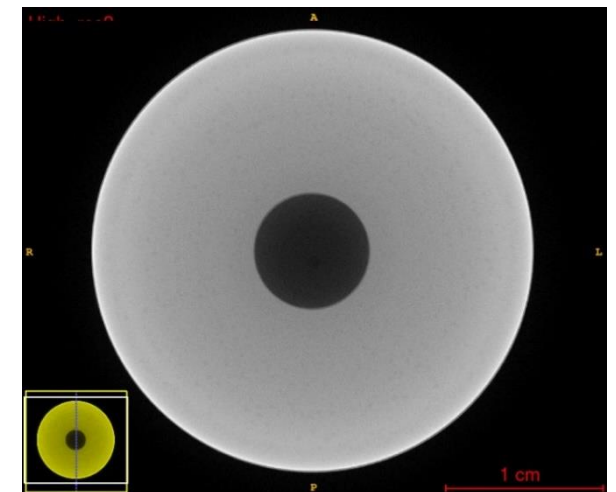
# Previews of CT scans of demonstrator part



87 microns



37 microns

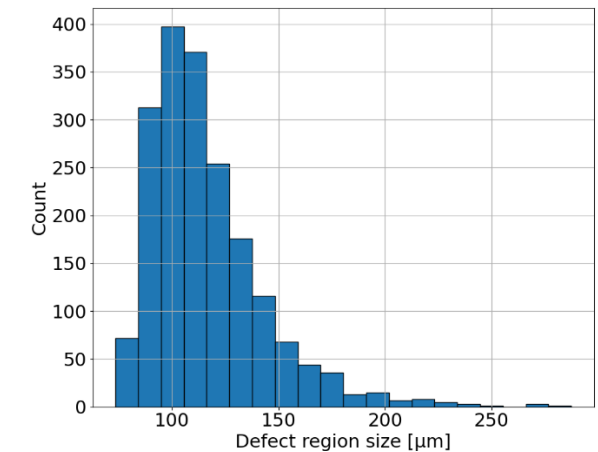
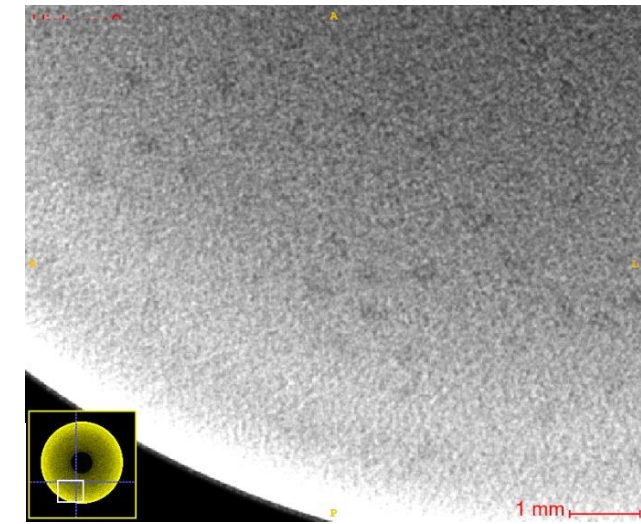
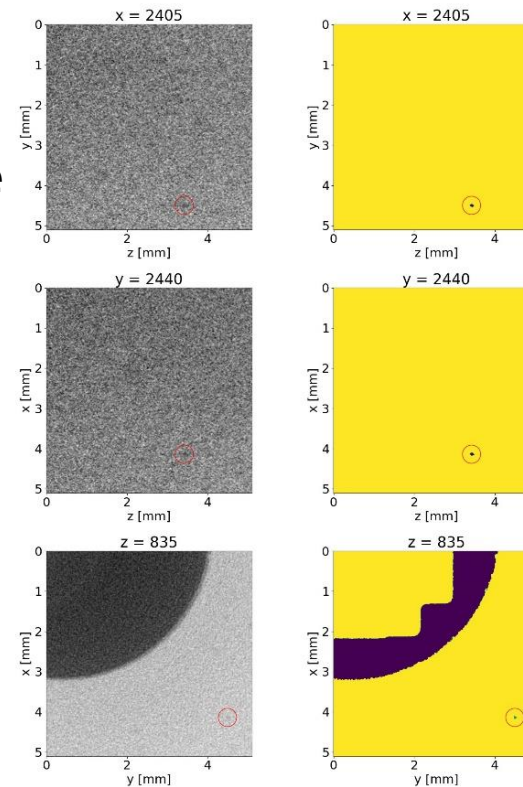


18 microns



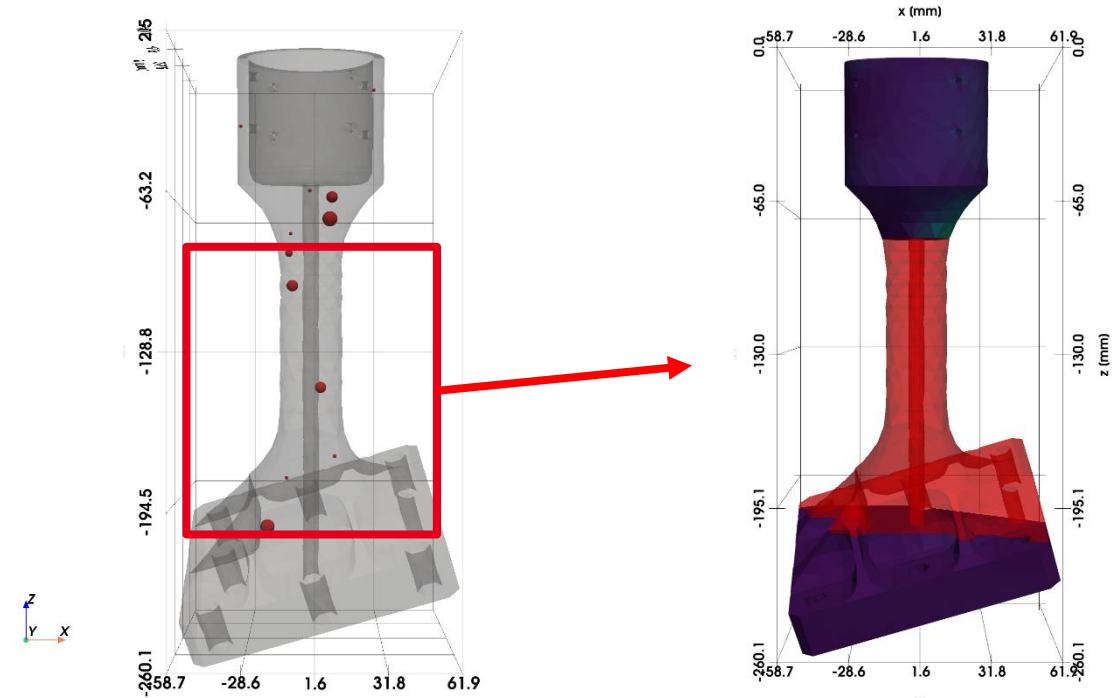
# Defect analysis based on CT data

- Close-up reveals large number of inhomogeneities within the material (visible only at highest resolution scale)
- Defect segmentation algorithm was applied to the scanned image
- The algorithm was able to identify a number of pores in the image (including information about location, size, and shape)



# Adaptive CT scanning procedure

- Aim: develop a methodology for optimized scanning of complex ceramic parts
  - Idea:
    - Start with coarse scan of the part
    - Combine information from FE analysis and defect locations at low-resolution
    - Refine scanning resolution in selected regions-of-interest (ROI) based on local critical defect size
- Could permit the presence of defects in regions of the part where low stresses are expected



# Defect assessment routine

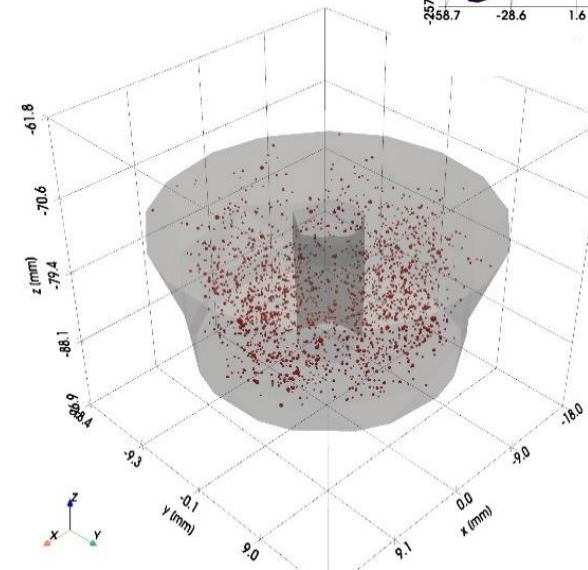
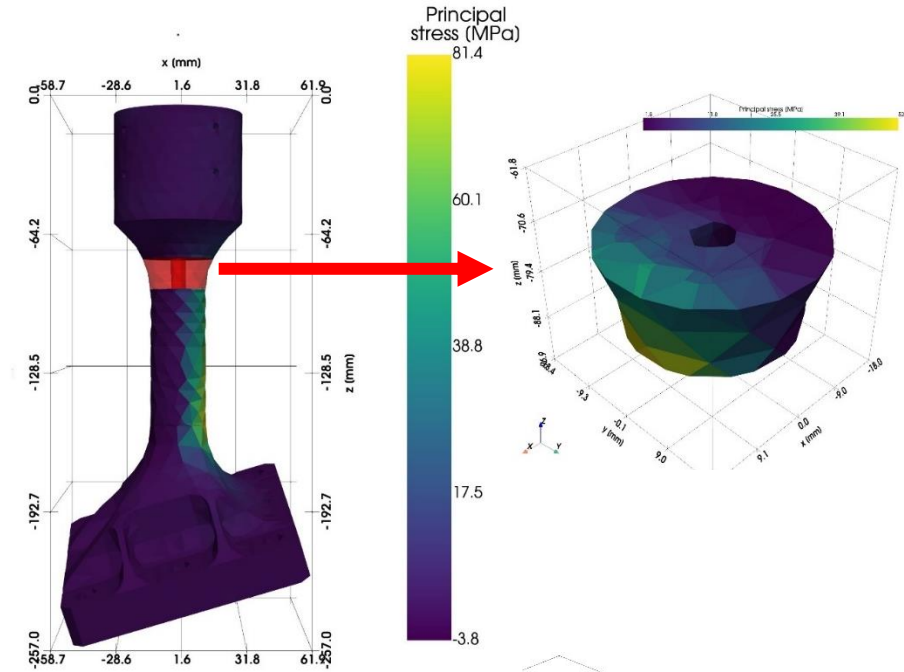
## ■ Inputs:

- $K_{IC}$ : fracture toughness of material
- $\sigma_f$ : tensile strength of material
- $\sigma_{FE}, \sigma_{FE}^{max}$ : FE local stress distribution, maximum local stress from FE
- $f$ : safety factor ( $\geq 1$ )

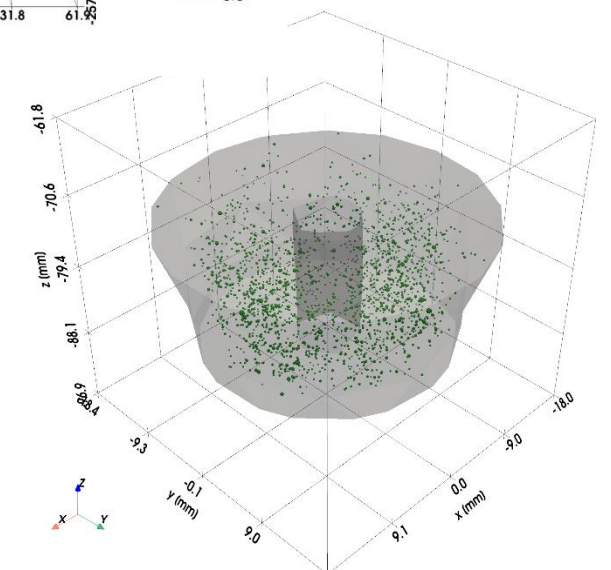
1. Calculate the global critical crack length of the material according to  $a_{glob} = \frac{1}{\pi} \left( \frac{K_{IC}}{\sigma_f} \right)^2$ .
2. Run segmentation algorithm for initial scan and mark all defects detected by the segmentation algorithm as **possibly critical**.
3. For each defect voxel region, perform the following steps:
  - a. Determine equivalent defect size  $a$ .
  - b. If  $a < a_{glob}$ , mark the defect as **not critical**.
  - c. Otherwise, compute the local stress  $\sigma_{loc}$  at the defect using the finite element simulation result  $\sigma_{FE}$  of the part under application load.
  - d. Compute a local critical crack length by  $a_{loc} = \frac{1}{\pi} \left( \frac{K_{IC}}{\sigma_{loc} f} \right)^2$ .
  - e. If  $a < a_{loc}$ , mark the defect as **not critical**.
4. Mark all remaining defects as **critical** → re-investigate at higher resolution scale.

# Demonstration of defect assessment routine

- Defect assessment is demonstrated for highest-resolution CT scan (10 microns) of upper section of the demonstrator part
- Image segmentation algorithm successfully identifies regions of inhomogeneities
- Mapping of FE stresses from bending test to defect locations and assessment using Griffith's criterion
- With the given material parameters, external load and safety factor of  $f = 1$  all defects are assessed as uncritical



Defects identified by segmentation algorithm



Evaluated defects (green = uncritical)

# Algorithm for adaptive scanning procedure

## ■ Inputs:

- $K_{IC}$ : fracture toughness of material
- $\sigma_f$ : tensile strength of material
- $\sigma_{FE}, \sigma_{FE}^{max}$ : FE local stress distribution, maximum local stress from FE
- $f$ : safety factor ( $> 1$ )

1. Determine resolution for initial scan  $W_0$  based on critical defect size from Griffith's criterion:

$$r_0 = \frac{1}{\pi} \left( \frac{K_{IC}}{\sigma_{FE}^{max} f} \right)^2$$

2. Perform image segmentation and evaluate defects using defect assessment routine (see previous slide).

3. If any **critical** defects remain, set next resolution  $r_i = \frac{r_{i-1}}{2}$

4. Generate scanner configuration files for taking new images  $W_i^j$  covering the locations of all critical defects

5. Resume adaptive algorithm at 2.

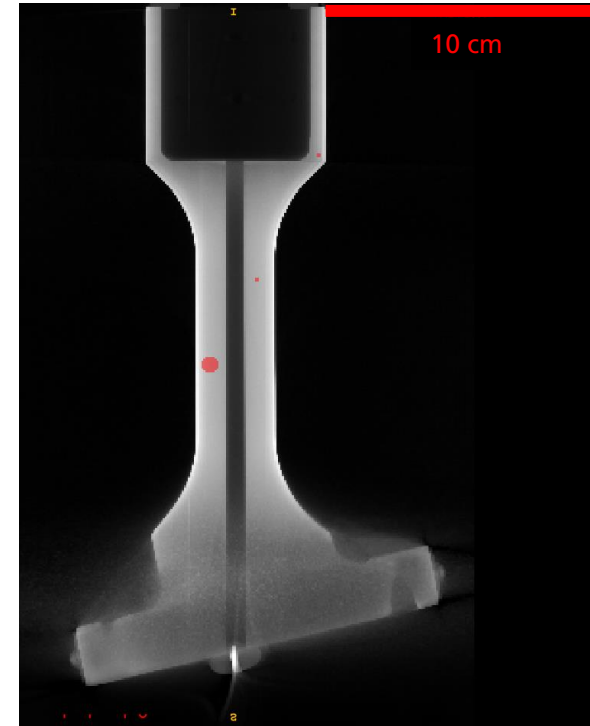
6. Terminate algorithm if:

- No **critical** defects remain or
- any defects have been confirmed as **critical** at two subsequent iterations or
- minimum resolution  $r_n < a_{glob}$  (global critical defect size) has been reached.

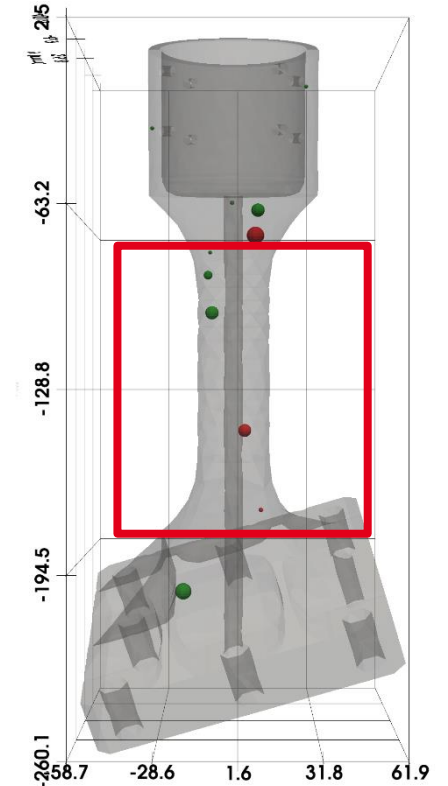
# Demonstration of adaptive algorithm

- Working principle of the adaptive algorithm is demonstrated using hypothetical pore locations
- Initial scan of full part at resolution of 695 microns
- Application of defect segmentation algorithm to identify defect locations
- Evaluation of detected defects using assessment procedure
- Generation of scanner configuration for higher-resolution scans parts of the image with critical defects
- Re-scanning of selected part → scan images  $W_1^1, W_1^2, W_1^3$

Initial scan  $W_0$

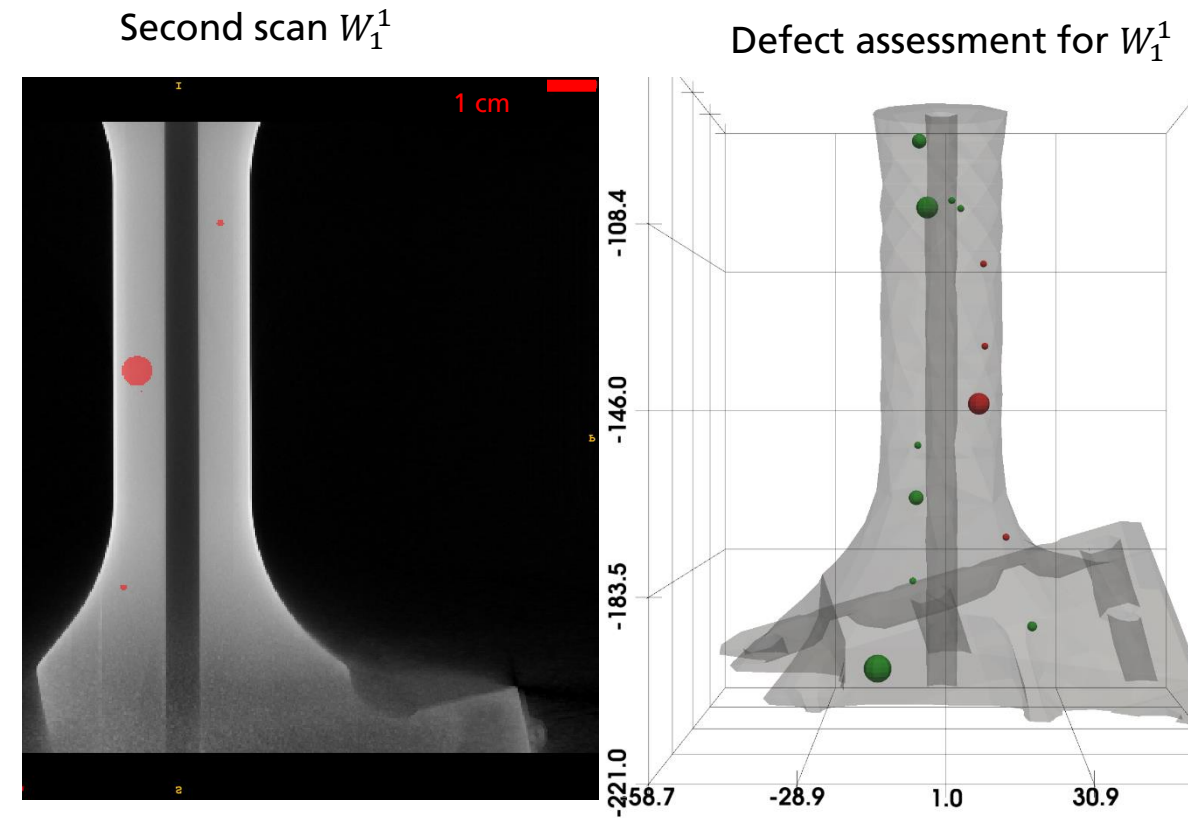


Defect assessment for  $W_0$



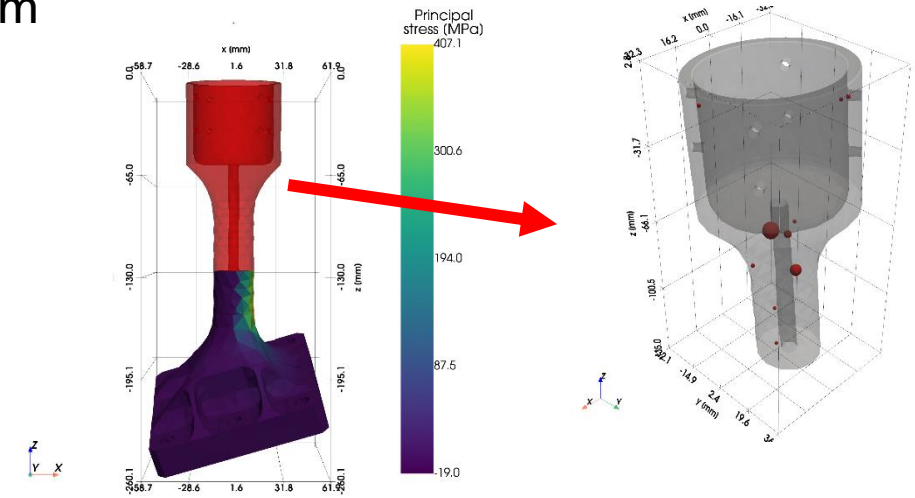
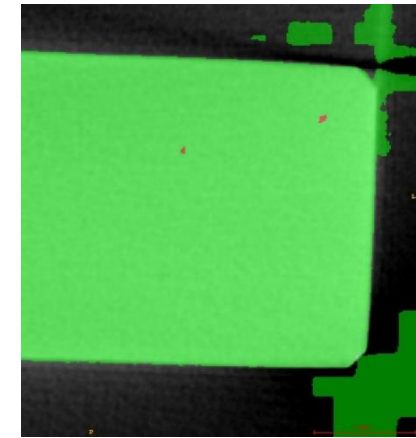
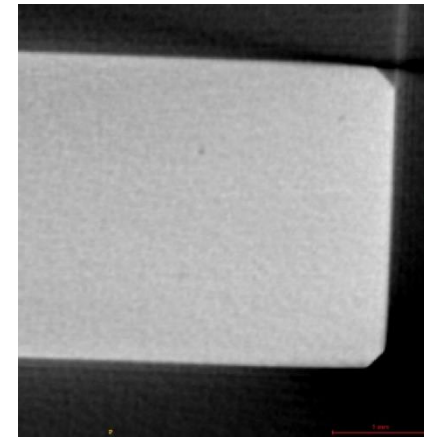
# Demonstration of adaptive algorithm

- Second scan of central region of the part at halved resolution of 347 microns
- Application of defect segmentation algorithm to identify defect locations
- Evaluation of detected defects using assessment procedure
- In this case, the algorithm would terminate, because a defect is marked as critical at two subsequent iterations



# Summary and conclusion

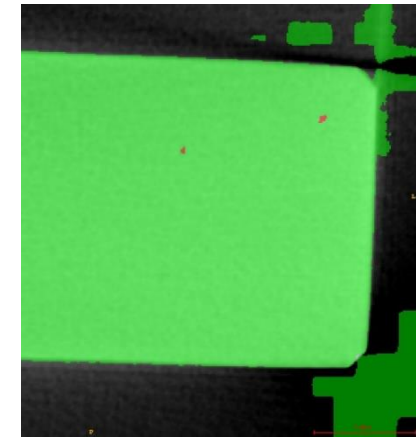
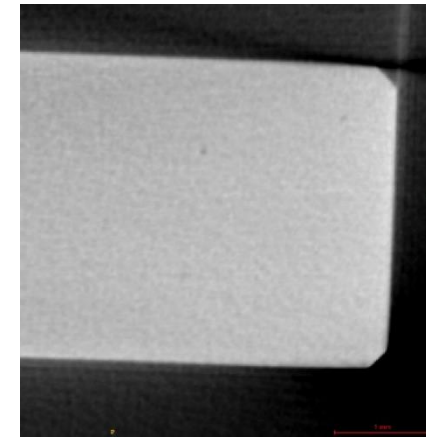
- An AI based method for defect detection and segmentation in CT images of ceramic components has been developed
- Information about detected defects is combined with data from FE analysis to enable assessment of defect under application conditions
- Defect assessment procedure is applied in adaptive fashion to enable iterative refinement of CT scanning resolution and reduce total scanning time
- Developed methodologies are demonstrated using a real  $\text{Si}_3\text{N}_4$  ceramic part





# Summary and conclusion

- An AI based method for defect detection and segmentation in CT images of ceramic components has been developed
- Information about defects can be used for FE analysis to enable simulation of different loading conditions
- Defect assessment possible to enable iterative refinement of design to reduce total scanning time
- Developed methodologies are demonstrated using a real  $\text{Si}_3\text{N}_4$  ceramic part



Thank you for your attention!

Any questions?

